

FEATURES

- Widely used in all kinds of battery packs
- High degree of inrush current capability
- Precise melting time
- Surface mount technology allows fuses to be directly attached to printed circuit boards
- Notebook Computer Wireless Base Station Networking Telecom System
- Significant savings in weight and real estate
- RoHS / REACH / AEC-Q200

RS PRO, Fuse, Ceramic SMD LTCC Chip Fuse, Fast Acting, 10A-30A, 1206

RS Stock No.: 2522159 2522160



RS Professionally Approved Products bring to you professional quality parts across all product categories. Our product range has been tested by engineers and provides a comparable quality to the leading brands without paying a premium price.

Surface Mount Fuse — LTCC Chip Fuse



Product Description

Ceramic SMD LTCC Chip Fuse, Fast Acting, 10A-30A, 1206

Applications:

- Notebook Computer
- Wireless Base Station
- Networking
- Telecom System
- Battery Management System (Battery Pack)

General Specifications

Current Rating	10A, 12A, 15A, 20A, 25A		30A
Voltage Rating	63V		48V
Body Material	Ceramic		
Interrupting Ratings	10A – 25A		፼ 63V DC ፼ 24V DC
	10A – 30A		ው 36V DC ወ 48V DC
	30A	300A (<u>መ</u> 24V DC
Operating Temperature	-55°C to +125°C		
Country of Origin	Taiwan		

Electrical Characteristics

	Opening Time		
Rated Current	1 In	3.5 In	
	Min.	Max.	
10A-30A	4 hr	5 sec	

Surface Mount Fuse — LTCC Chip Fuse



I ² t Nominal Cold Resistance & I ²	² t &Safety Approval:
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Approvals	Marking	Interrupting rating	c AV *us	Nominal Cold Resistance (Ohms)	Nominal Melting I ² t (A ² sec.)
10A	10		*	0.0038 - 0.0070	14
12A	12	100A @ 63V DC	*	0.0028 - 0.0052	19
15A	15	200A @ 36V DC	*	0.0023 - 0.0043	33
20A	20	250A @ 24V DC	*	0.0014 - 0.0026	56
25A	25		*	0.0012 - 0.0022	182
30A	30	150A @ 48V DC 200A @ 36V DC 300A @ 24V DC	*	0.0009 - 0.0017	260

Shape & Dimension:

L1

L2

w

Туре	1206
L	3.1 ± 0.2 mm
W	1.6 ± 0.2 mm
Т	0.9 ± 0.2 mm
BW	0.5 ± 0.25 mm





